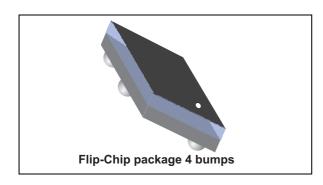
BALF-2690-02D3



50 ohm nominal input / conjugate match balun for STLC2690, with integrated harmonic filter

Datasheet - production data



Features

- 50 Ω nominal input / matched output differential impedance
- Integrated harmonic filter
- · Low insertion loss
- Low amplitude imbalance
- · Low phase imbalance
- Small footprint < 1.54 mm²

Benefits

- Very low profile (< 560 µm after reflow)
- High RF performance
- RF BOM and area reduction

Applications

- Bluetooth STLC2690 application
- Mobile phone application

Description

STMicroelectronics BALF-2690-02D3 is a balun design to transform single ended signal to differential signals in Bluetooth applications. This BALF-2690-02D3 has been customized for STLC2690 Bluetooth transceiver with less than 1.2 dB insertion losses in the bandwidth (2400 MHz-2500 MHz).

The BALF-2690-02D3 has been designed using STMicroelectronics IPD (integrated passive device) technology on non-conductive glass substrate which optimize RF performances.

Figure 1. Device configuration (top view)

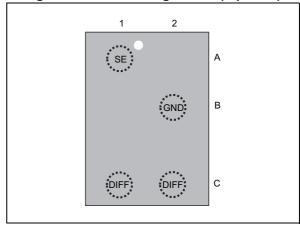
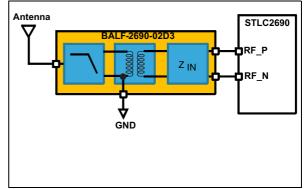


Figure 2. Application schematic



Characteristics BALF-2690-02D3

1 Characteristics

Table 1. Absolute maximum ratings (limiting values)

Symbol	Parameter		Value		
			Тур.	Max.	- Unit
P _{IN}	Input power RFIN		10	13	dBm
V _{ESD}	ESD rating, human body model (JESD22-A114-C) all I/O one at a time while others connected to GND	2000			V
	ESD rating, machine model, all I/O	200			
T _{OP}	Operating temperature range	-40		+85	°C

Table 2. Impedances (T_{amb} = 25 °C)

Symbol	Parameter	Value			
Symbol	r ai ailletei	Min.	Тур.	Max.	Unit
Z _{DIFF}	Nominal differential impedance	ninal differential impedance matched to STLC2690		Ω	
Z _{SE}	Nominal single-ended impedance		50	22	

Table 3. RF performance ($T_{amb} = 25 \text{ °C}$)

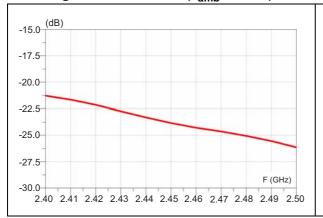
Symbol	Parameter	Test condition	Value			Unit
	Faranietei	rest condition	Min.	Тур.	Max.	Oilit
f	Frequency range (bandwidth)		2400		2500	MHz
Ι _L	Insertion loss in bandwidth			+1.2		dB
R _{L_SE}	Return loss in bandwidth		15	21		dB
ϕ_{imb}	Output phase imbalance (single ended)		-10		+10	0
A _{imb}	Output amplitude imbalance		-1	0.5	1	dB
CMRR	Common mode rejection (S _{SC12})		20			dB
Att _{2fo}	2nd harmonic S21 attenuation	4800-5000 MHz	31			dB
Att _{3f0}	3rd harmonic S21 attenuation	7200-7500 MHz	36			uБ

BALF-2690-02D3 Characteristics

1.1 Measurements

Figure 3. Return loss (T_{amb} = 25 °C)

Figure 4. Insertion loss (T_{amb} = 25 °C)



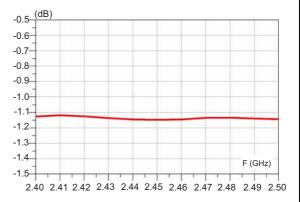
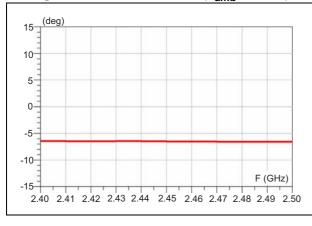


Figure 5. Phase imbalance ($T_{amb} = 25$ °C)

Figure 6. Amplitude imbalance (T_{amb} = 25 °C)



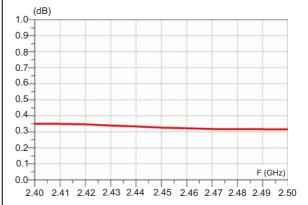
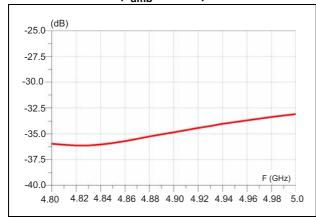
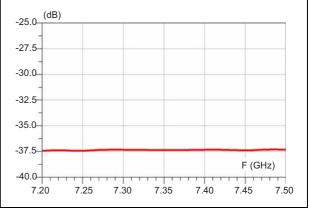


Figure 7. Transmission: 2nd harmonic (dB) $(T_{amb} = 25 \, ^{\circ}C)$

Figure 8. Transmission: 3rd harmonic (dB) $(T_{amb} = 25 \text{ °C})$





Characteristics BALF-2690-02D3

0 (dB)
-10
-20
-30
-40
-50
-60
-70
0 1 2 3 4 5 6 7 8 9 10

Figure 9. Transmission (dB)

2 Package information

- Epoxy meets UL94, V0
- Lead-free package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Bottom view GND 0.94 mm ± 50 µm DIFF SE 1.64 mm ± 50 µm Top view DIFF SE 500 µm Diam: 255 μm 215 µm_| DIFF **GND** 225 μm 215 µm 660 µm 540 µm Side view 630 µm

Figure 10. Package dimensions

Package information BALF-2690-02D3

Figure 11. Footprint - non solder mask Figure 12. Footprint - solder mask defined defined

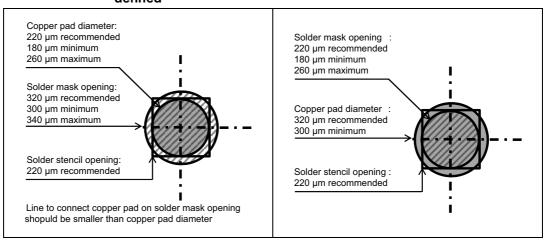


Figure 13. Marking

Figure 14. Recommended land pattern

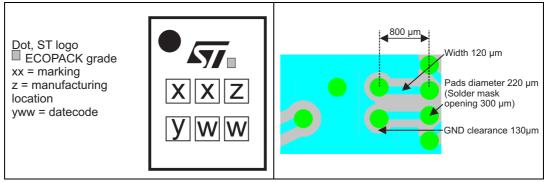
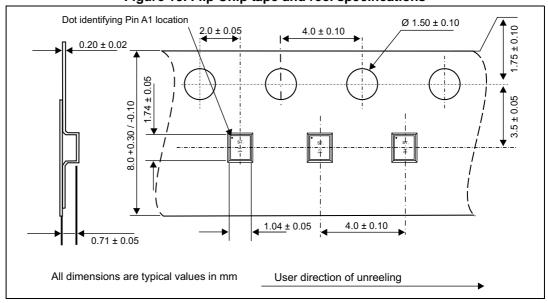


Figure 15. Flip Chip tape and reel specifications



Note: More information is available in the STMicroelectronics application notes: AN2348 Flip-Chip: "Package description and recommendations for use"

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3 Ordering information

Table 4. Ordering information

Order code	Marking	Weight	Base Qty	Delivery mode
BALF-2690-02D3	SP	1.81 mg	5000	Tape and Reel

4 Revision history

Table 5. Document revision history

Date	Revision	Changes
27-Sep-2013	1	Initial release
19-Dec-2013	2	Added product weight in <i>Table 4</i> and updated <i>Table 1</i> .
19-Nov-2014	3	Added tape and reel dimensions.

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